

FEATURES

- Spread Spectrum Clock Generator/Multiplier with output selectable from 1x to 8x.
- 10MHz to 240MHz output with output enable.
- 10MHz to 30 MHz reference input frequency accepted from crystal or external clock signal.
- Reduced EMI from Spread Spectrum Modulation, with selectable modulation amplitude for Center Spread, Down Spread or Asymmetric Spread.
- TTL/CMOS compatible outputs.
- 3.3V Operating Voltage.
- 100 ps maximum cycle-to-cycle jitter.
- Available in 16-Pin 150mil SSOP or DIE.

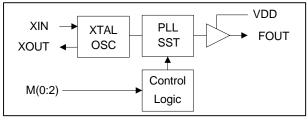
DESCRIPTIONS

The PLL701-10 is a low EMI Clock Generator and Multiplier for high-speed digital systems. It uses Spread Spectrum Technology (SST) and permits different levels of EMI reduction by selecting the amplitude of the applied SST. The SST feature can be turned off. An output enable input is also used. The chip operates with input frequencies ranging from 10 to 30 MHz and provides 1x to 8x at its output.

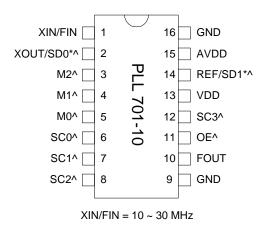
OUTPUT CLOCK (FOUT) SELECTION

M2	M1	MO	FIN/XIN (MHz)	Multiplier	FOUT (MHz)
0	0	0		X1	10 ~ 30
0	0	1		X2	20 ~ 60
0	1	0		X3	30 ~ 90
0	1	1	10 ~ 30	Χ4	40 ~ 120
1	0	0	10 % 50	X5	50 ~ 150
1	0	1		Х6	60 ~ 180
1	1	0		X7	70 ~ 210
1	1	1		X8	80 ~ 240

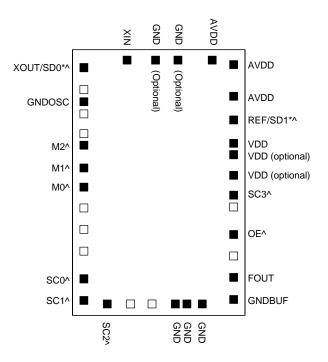
BLOCK DIAGRAM



PACKAGE PIN CONFIGURATION



DIE PAD CONFIGURATION



- Note: ^: Internal pull-up resistor ($120k\Omega$ for SD0, $30 k\Omega$ for SC0-SC2, SD1, M0-M2 and OE). The internal pull-up resistor results in a default high value when no pull-down resistor is connected to this pin.
 - *: SD0 and SD1 are latched upon power-up.



SPREAD SPECTRUM SELECTION TABLE

SD1	SD0	SC3	SC2	SC1	SC0	Modulation Magnitude	Modulation Frequency	Modulation Type
1	1	0	0	0	0	0.250%		C ± 0.125%
1	1	0	0	0	1	0.500%		C ± 0.25%
1	1	0	0	1	0	0.750%] [C ± 0.375%
1	1	0	0	1	1	1.000%]	C ± 0.50%
1	0	0	0	1	1	1.00078		D -1.00%
1	1	0	1	0	0	1.250%		C ± 0.625%
1	0	0	1	0	0	1.20070	-	A +0.125 ~ -1.125%
1	1	0	1	0	1	1.500%		C ± 0.75%
1	0	0	1	0	1		-	A +0.25 ~ -1.25%
1	1	0	1	1	0	1.750%		C ± 0.875%
1	0	0	1	1	0			A +0.375 ~ -1.375%
1	1	0	1	1	1			C ± 1.00%
1	0	0	1	1	1	2.000%		A +0.50 ~ -1.5%
0	1	0	1	1	1		-	D -2.00%
1	1	1	0	0	0			C ± 1.125%
1	0	1	0	0	0	2.250%		A +0.625 ~ -1.625%
0	1	1	0	0	0		-	A +0.125 ~ -2.125%
1	1	1	0	0	1			C ± 1.25%
0	1	1	0	0	1	2.500%		A +0.25 ~ -2.25%
1	0	1	0	0	1		-	A +0.75 ~ -1.75%
1	1	1	0	1	0			C ± 1.375%
1	0		0	1	0	2.750%	Fin / 512	A +0.875 ~ -1.875%
0	1	1	0	1	0		-	A +0.375 ~ -2.375% C ± 1.50%
1	1	1	0	1	1			
0	0	1	0	1	1	3.000%		D -3.00% A +1.00 ~ -2.00%
0	1	1	0	1	1			A +0.50 ~ -2.50%
1	1	1	1	0	0			$A +0.50 \sim -2.50\%$ C ± 1.625%
1	0	1	1	0	0			A +1.125 ~ -2.125%
0	1	1	1	0	0	3.250%		A +0.625 ~ -2.625%
0	0	1	1	0	0			A +0.125 ~ -3.125%
1	1	1	1	0	1		-	C ± 1.75%
1	0	1	1	0	1			A +1.25 ~ -2.25%
0	1	1	1	0	1	3.500%		A +0.75 ~ -2.75%
0	0	1	1	0	1			A +0.25 ~ -3.25%
1	1	1	1	1	0			C ± 1.875%
1	0	1	1	1	0			A +1.37 ~ -2.375%
0	1	1	1	1	0	3.750%		A +0.875 ~ -2.875%
0	0	1	1	1	0			A +0.375 ~ -3.375%
1	1	1	1	1	1		1	SST turned off
1	0	1	1	1	1			SST turned off
0	1	1	1	1	1	0.00 %		SST turned off
0	0	1	1	1	1			SST turned off

Notes: C: Center Spread. A: Asymmetric Spread. D: Down Spread.



PIN/PAD DESCRIPTIONS

Name	Pin #	Pad #	Туре	Description	
XIN/FIN	1	22	I	Crystal input to be connected to fundamental parallel mode crystal. ($C_L=20pF$) or clock input.	
XOUT/SD0	2	23	В	At power-up, this pin is acts as input pin to select the modulation rate and is latched in. After the input sampling, it is used as crystal output connector. $120k\Omega$ internal pull up resistor.	
M2	3	28	Ι	Digital control input to select output frequency. 30k $\!\Omega$ internal pullup.	
M1	4	29	Ι	Digital control input to select output frequency. 30k $\!\Omega$ internal pullup.	
MO	5	30	I	Digital control input to select output frequency. 30k Ω internal pullup.	
SC0	6	34	I	Digital control input to select spread spectrum modulation. $30k\Omega$ internal pull-up.	
SC1	7	35	Ι	Digital control input to select spread spectrum modulation. $30k\Omega$ internal pull-up.	
SC2	8	1	Ι	Digital control input to select spread spectrum modulation. $30k\Omega$ internal pull-up.	
SC3	12	12	Ι	Digital control input to select spread spectrum modulation. $30k\Omega$ internal pull-up.	
FOUT	10	8	0	Modulated Clock Frequency Output. The frequency before modulation is synthesized by multiplying the input frequency by 1X to 8X, depending on SD(0:1) and SC(0:3).	
OE	11	10	I	Output Enable. When low, Tri-states all outputs. $30k\Omega$ internal pull-up.	
VDD	13	13,14,15	Р	3.3V Power Supply.	
REF/SD1	14	16	В	At power-up, this pin acts as input pin to select the modulation rand is latched in. After the input sampling, this pin provides a buffered Reference Clock Output of the same frequency as the crystal or clock input. $30k\Omega$ internal pull-up.	
AVDD	15	17,18,19	Р	3.3V Analog power supply.	
GNDOSC	N/A	25	Р	Ground for Oscillator circuitry.	
GNDBUF	N/A	7	Р	Ground for output buffer circuitry.	
GND	9 and 16	4,5,6,20,21	Р	Ground.	

Notes: B – bi-directional pin; I – input pin; P – power supply/ground pin.



FUNCTIONAL DESCRIPTION

Selectable spread spectrum and modulation rates

The PLL701-10 provides selectable multiplier factors (1x to 8X), selectable spread spectrum modulation, as well as selectable modulation rate. Selection is made by connecting specific input pins to a logical "zero" or "one". Pins 6 (SCO), 7 (SC1), 8 (SC2) and 12 (SC3) are used as inputs to select the spread spectrum modulation as shown on the spread spectrum selection table (page 2). Pins 3 (M2), 4 (M1), 5 (M0) are used as inputs to select the output frequency as shown on the output clock selection table (page 1). Pin 11 is the output enable pin, that tri-states all outputs when low (logical "zero").

In order to reduce the number of pins on the chip, the PLL701-10 uses pin 2 and 14 (XOUT/SD0 and REF/SD1) as a bi-directional pin. The pins serve as modulation rate selector inputs (SD0 and SD1) upon power-up (see modulation rate table on page 1), and as XOUT crystal connection (pin 2), and REF output signal (pin 14) as soon as the inputs have been latched.

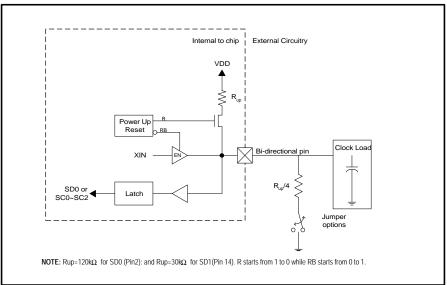
Connecting a selection pin to a logical "one"

All selection pins have an internal pull-up resistor $(30k\Omega \text{ for pins } 3, 4, 5, 6, 7, 8, 11, 12, 14 \text{ and } 120k\Omega \text{ for pin } 2)$. This internal pull-up resistor will pull the input value to a logical "one" (pull-up) by default, i.e. when no resistive load is connected between the pin and GND. No external pull-up resistor is therefore required for connecting a logical "one" upon power-up.

Connecting a selection pin to a logical "zero"

For an input only pin, i.e. all input pins except XOUT/SD0 (pin 2) and REF/SD1 (pin 14), the pin simply needs to be grounded to pull the input down to a logical "zero". Connecting the bi-directional pins (SD0 and SD1) to a logical "zero" will however require the use of an external loading resistor between the pin and GND that has to be sufficiently small (compared to the internal pull-up resistor) so that the pin voltage be pulled below 0.8V (logical "zero"). In order to avoid loading effects when the pin serves as output, the value of the external pull-down resistor should however be kept as large as possible. In general, it is recommended to use an external resistor of around Rup/4 (e.g. $27k\Omega$ for pin 2 and $4.7k\Omega$ for pin 14, see Application Diagram).

APPLICATION DIAGRAM FOR OUTPUT AND MODULATION SELECTION





ELECTRICAL SPECIFICATIONS

1. Absolute Maximum Ratings

PARAMETERS	SYMBOL	MIN.	MAX.	UNITS
Supply Voltage	V _{DD}	V _{SS} -0.5	6	V
Input Voltage Range	VI	V _{SS} -0.5	V _{DD} +0.5	V
Output Voltage Range	Vo	Vss-0.5	V _{DD} +0.5	V
Soldering Temperature			260	°C
Storage Temperature	Τs	-65	150	°C
Ambient Operating Temperature*	TA	-40	85	°C

Exposure of the device under conditions beyond the limits specified by Maximum Ratings for extended periods may cause permanent damage to the device and affect product reliability. These conditions represent a stress rating only, and functional operations of the device at these or any other conditions above the operational limits noted in this specification is not implied.

* Note: Operating Temperature is guaranteed by design for all parts (COMMERCIAL and INDUSTRIAL), but tested for INDUSTRIAL grade only.

2. DC/AC Specification

PARAMETERS	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Supply Voltage	Vdd		3.15		3.45	V
Input High Voltage	VIH		0.7*VDD			V
Input Low Voltage	VIL				0.3*VDD	V
Input High Current	I _{IH}				100	μA
Input Low Current	IIL				100	μA
Output High Voltage	Vон	Iон=5mA, VDD=3.3V	2.4			
Output Low Voltage	Vol	I _{OL} =6mA, VDD=3.3V			0.4	
	Fxin	When using a crystal	15		30	MHz
Input Frequency	Fin	When using reference clock	15		30	MHz
Maximum interruption of F_{IN}		When using reference clock			100	μs
Load Capacitance	CL	Between Pin XIN and XOUT*		18		pF
Pull-up Resistor	R _{up}	PIN 2		120		kΩ
Pull-up Resistor	Rup	PIN 3,4,5,6,7,8,11,12		30		kΩ
Short Circuit Current	Isc			25		mA
3.3V Dynamic Supply Current	Icc	No Load		20		mA

*Note: Pin XIN and XOUT each has a 36pF capacitance. When used with a XTAL, the two capacitors combined load the crystal with 18pF. If driving XIN with a reference clock signal, the load capacitance will be 36pF (typical).



3. TIMING CHARACTERISTICS

PARAMETERS	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Rise Time	Tr	Measured at 0.8V ~ 2.0V @ 3.3V	0.8	0.95	1.1	ns
Fall Time	Tf	Measured at 2.0V ~ 0.8V @ 3.3V	0.78	0.85	0.9	ns
Output Duty Cycle	DT		45	50	55	%
Cycle to Cycle Jitter	Тсус-сус	FOUT=48MHz @ 3.3V			100	ps
Cycle to Cycle Jitter	Тсус-сус	FOUT=72MHz @ 3.3V			100	ps

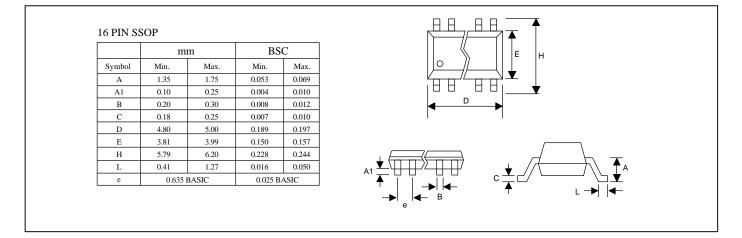


PAD ASSIGNMENT (LOWER LEFT CORNER: X = 0, Y = 0)

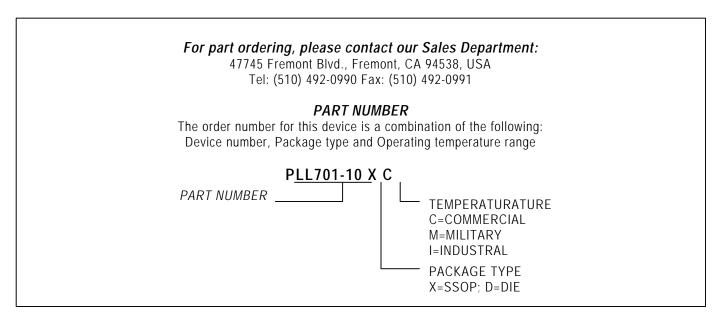
Pad #	Name	X (μm)	Υ (μm)
1	SC2	338.9	104.7
2	N/C	569	104.7
3	N/C	780.5	104.7
4	GND	1027.6	104.7
5	GND	1127.3	104.7
6	GND	1284.5	104.7
7	GNDBUF	1595.1	139.7
8	FOUT	1595.1	381.7
9	N/C	1595.1	596.3
10	OE	1595.1	811.9
11	N/C	1595.1	970.3
12	SC3	1595.1	1069.3
13	VDD (Optional)	1595.1	1312.3
14	VDD (Optional)	1595.1	1555.6
15	VDD	1595.1	1656.8
16	REF/SD1	1595.1	1879.9
17	AVDD	1595.1	2093
18	AVDD	1595.1	2390.6
19	AVDD	1369.2	2435
20	GND (Optional)	1037.3	2435
21	GND (Optional)	824.7	2435
22	XIN	529.7	2435
23	XOUT/SD0	105.6	2343.5
24	N/C	105.6	2136.1
25	GNDOSC	105.6	2035.6
26	N/C	105.6	1934.9
27	N/C	105.6	1741.5
28	M2	105.6	1641.4
29	M1	105.6	1396.2
30	N/C	105.6	1180.3
31	N/C	105.6	993.5
32	N/C	105.6	836.7
33	N/C	105.6	680.1
34	SC0	105.6	354.9
35	SC1	105.6	110.7



PACKAGE INFORMATION (DIE INFORMATION TO BE ADDED)



ORDERING INFORMATION



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